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January 2007

FDY3000NZ

FAIRCHILE

Dual N-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

This Dual N-Channel MOSFET has been designed using Fairchild Semiconductor's advanced Power Trench process to optimize the $R_{DS(ON)}$ @ V_{GS} = 2.5v.

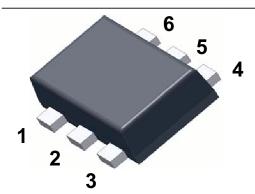
Applications

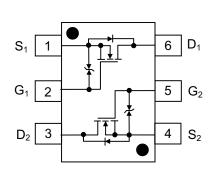
Li-Ion Battery Pack



Features

- 600 mA, 20 V $R_{DS(ON)}$ = 700 m Ω @ V_{GS} = 4.5 V $R_{DS(ON)}$ = 850 m Ω @ V_{GS} = 2.5 V
- ESD protection diode (note 3)
- RoHS Compliant





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		± 12	V
I _D	Drain Current – Continuous	(Note 1a)	600	mA
	– Pulsed		1000	
PD	Power Dissipation (Steady State)	(Note 1a)	625	mW
		(Note 1b)	446	
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

R _{0JA}	Thermal Resistance, Junction-to-Ambient (Note 1a)	200	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1b)	280	

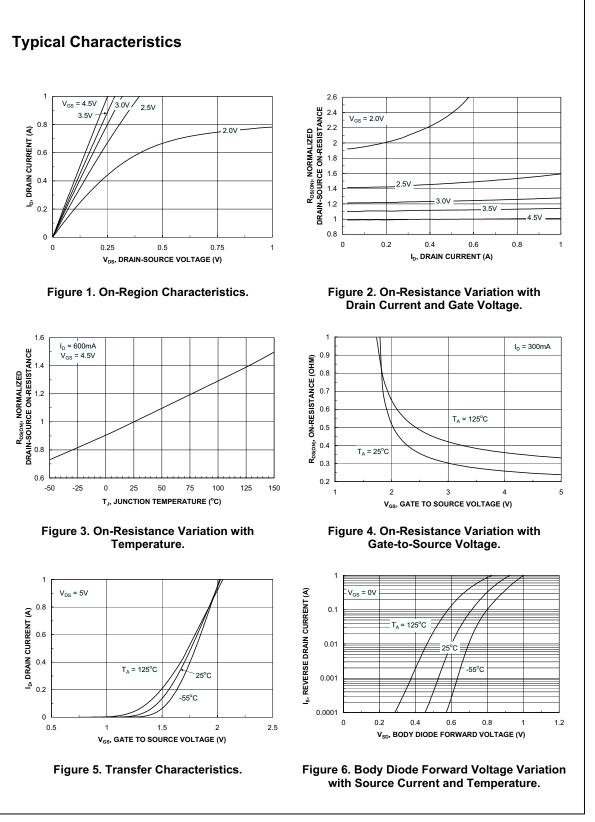
Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
С	FDY3000NZ	7 "	8 mm	3000 units

Parameter	Test Conditions	Min	Тур	Max	Units
cteristics	I		1		
Drain–Source Breakdown	$V_{GS} = 0 V$, $I_{D} = 250 \mu A$	20			V
Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		14		mV/°C
Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
Gate–Body Leakage,	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$			± 10	μA
	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$			± 1	μA
cteristics (Note 2)					
Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.6	1.0	1.3	V
Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		- 3		mV/°C
Static Drain–Source On–Resistance			0.25 0.37 0.73 0.35	0.70 0.85 1.25 1.00	Ω
Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 600 mA$		1.8		S
Characteristics					
Input Capacitance	$V_{DS} = 10 V_{.}$ $V_{CS} = 0 V_{.}$		60		pF
Output Capacitance	f = 1.0 MHz		20		pF
Reverse Transfer Capacitance			10		pF
	I		1	1 1	
		[6	12	20
					ns
	NGS 1.0 V, NGEN 0 12		-		ns
					ns
					ns
				1.1	nC
•					nC
Gate–Drain Charge			0.26		nC
urce Diode Characteristics	and Maximum Ratings				
Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 150 mA$ (Note 2)		0.7	1.2	V
Diode Reverse Recovery Time	I _F = 600 mA,		8		nS
Diode Reverse Recovery Charge	dI _F /dt = 100 A/µs		1		nC
	Drain–Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate–Body Leakage, Cteristics (Note 2) Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain–Source On–Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Fall Time Turn–Off Fall Time Total Gate Charge Gate–Drain Charge Urce Diode Characteristics Drain–Source Diode Forward Voltage Diode Reverse Recovery Time	Drain-Source Breakdown Voltage $V_{GS} = 0 \text{ V}$, $I_D = 250 \ \mu\text{A}$ Breakdown Voltage Temperature Coefficient $I_D = 250 \ \mu\text{A}$, Referenced to 25°C Zero Gate Voltage Drain Current $V_{DS} = 16 \text{ V}$, $V_{GS} = 0 \text{ V}$ Gate-Body Leakage, $V_{GS} = \pm 12 \text{ V}$, $V_{DS} = 0 \text{ V}$ Gate-Body Leakage, $V_{GS} = \pm 4.5 \text{ V}$, $V_{DS} = 0 \text{ V}$ Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu\text{A}$ Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu\text{A}$ Gate Threshold Voltage $V_{DS} = 10 \text{ V}$, $I_D = 250 \ \mu\text{A}$ Gate Threshold Voltage $V_{DS} = 4.5 \text{ V}$, $I_D = 600 \ m\text{A}$ On-Resistance $V_{GS} = 4.5 \text{ V}$, $I_D = 600 \ m\text{A}$ On-Resistance $V_{DS} = 5 \text{ V}$, $I_D = 600 \ m\text{A}$ V_{GS} = 4.5 V, $I_D = 600 \ m\text{A}$ $V_{GS} = 1.8 \text{ V}$,Input Capacitance $V_{DS} = 5 \text{ V}$, $I_D = 600 \ m\text{A}$ CharacteristicsInput Capacitance $V_{DS} = 10 \ V$, $V_{GS} = 0 \ V$,f turn-On Delay Time $V_{DD} = 10 \ V$, $I_D = 1 \ A$,Turn-On Rise Time $V_{DS} = 10 \ V$, $I_D = 600 \ m\text{A}$,Turn-Off Fall Time $V_{DS} = 10 \ V$, $I_D = 600 \ m\text{A}$,Turn-Off Fall Time $V_{DS} = 10 \ V$, $I_D = 600 \ m\text{A}$,Gate-Drain Charge $V_{GS} = 0 \ V$, $I_D = 600 \ m\text{A}$,Gate-Drain Charge $V_{GS} = 0 \ V$, $I_D = 600 \ m\text{A}$,Drain-Source Diode Forward $V_{GS} = 0 \ V$, $I_S = 150 \ m\text{A}$ (Note 2)Outa	$\begin{array}{ c c c c c } \hline Drain-Source Breakdown \\ V_{GS} = 0 V, & I_{D} = 250 \ \mu\text{A}, \ Referenced to 25^{\circ}\text{C} \\ \hline Coefficient \\ \hline Zero Gate Voltage Drain Current \\ Gate-Body Leakage, \\ \hline V_{GS} = 16 V, & V_{GS} = 0 V \\ \hline Gate-Body Leakage, \\ \hline V_{GS} = \pm 12 V, & V_{DS} = 0 V \\ \hline V_{GS} = \pm 12 V, & V_{DS} = 0 V \\ \hline V_{GS} = \pm 4.5 V, & V_{DS} = 0 V \\ \hline Cteristics (Note 2) \\ \hline Gate Threshold Voltage \\ Temperature Coefficient \\ \hline Static Drain-Source \\ On-Resistance \\ \hline N_{GS} = 1.8 V, & I_{D} = 500 \ \text{mA} \\ V_{GS} = 1.8 V, & I_{D} = 500 \ \text{mA} \\ V_{GS} = 1.8 V, & I_{D} = 500 \ \text{mA} \\ V_{GS} = 1.8 V, & I_{D} = 500 \ \text{mA} \\ \hline V_{GS} = 1.8 V, & I_{D} = 600 \ \text{mA} \\ \hline On-Resistance \\ \hline Drance \\ \hline Forward Transconductance \\ \hline V_{DS} = 5 V, & I_{D} = 600 \ \text{mA} \\ \hline V_{GS} = 1.0 \ \text{MHz} \\ \hline \hline Characteristics \\ \hline Input Capacitance \\ \hline Drance \\ \hline Turn-On Delay Time \\ \hline Turn-On Rise Time \\ \hline Turn-Off Delay Time \\ \hline Turn-Off Fall Time \\ \hline Turn-Off Fall Time \\ \hline Total Gate Characteristics and Maximum Ratings \\ \hline Drain-Source Diode Forward \\ \hline V_{GS} = 0 V, I_{S} = 150 \ \text{mA} \\ \hline N_{GS} = 0 V, I_{S} = 150 \ \text{mA} \\ \hline V_{GS} = 0 V, I_{S} = 150 \ \text{mA} \\ \hline Drain-Source Diode Forward \\ \hline V_{GS} = 0 V, I_{S} = 150 \ \text{mA} \\ \hline Diode Reverse Recovery Time \\ \hline I_{F} = 600 \ \text{mA} \\ \hline V_{GS} = 0 V, I_{S} = 150 \ \text{mA} \\ \hline V_{GS} = 0 V, I_{S} = 150 \ \text{mA} \\ \hline Diode Reverse Recovery Time \\ \hline V_{GS} = 0 \ V, I_{S} = 150 \ \text{mA} \\ \hline N_{CS} = 0 \ V, I_{S} = 150 \ \text{mA} \\ \hline N_{CS} = 0 \ V, I_{S} = 150 \ \text{mA} \\ \hline N_{CS} = 0 \ V, I_{S} = 150 \ \text{mA} \\ \hline \hline Drain-Source Diode Forward \\ \hline V_{GS} = 0 \ V, I_{S} = 150 \ \text{mA} \\ \hline N_{CS} = 0 \ V, I_{S} = 150 \ \text{mA} \\ \hline \hline \hline \hline Drain-Source Diode Forward \\ \hline V_{CS} = 0 \ V, I_{S} = 150 \ \text{mA} \\ \hline \hline \hline \hline \ Drain-Source Diode Forward \\ \hline $	$\begin{array}{ c c c c c } \hline Drain-Source Breakdown \\ Voltage \\ \hline Breakdown Voltage Temperature \\ Coefficient \\ \hline I_{D} = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline I_{A} \\ \hline D = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline I_{A} \\ \hline D = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline I_{A} \\ \hline D = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline D = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline D = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline D = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline D = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ 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250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline D = 250 \ \mu\text{A}, I_{D} = 500 \ \text{mA} \\ \hline 0 25 \ O n-Resistance \\ \hline D = 250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} \\ \hline D = 250 \ \mu\text{A}, I_{D} = 500 \ \text{mA} \\ \hline 0 25 \ O n-Resistance \\ \hline D = 250 \ \mu\text{A}, I_{D} = 600 \ \text{mA} \\ \hline 0 25 \ O n-Resistance \\ \hline D = 25 \ V, I_{D} = 600 \ \text{mA} \\ \hline 1 0 \\ \hline D \\ D \\$	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$

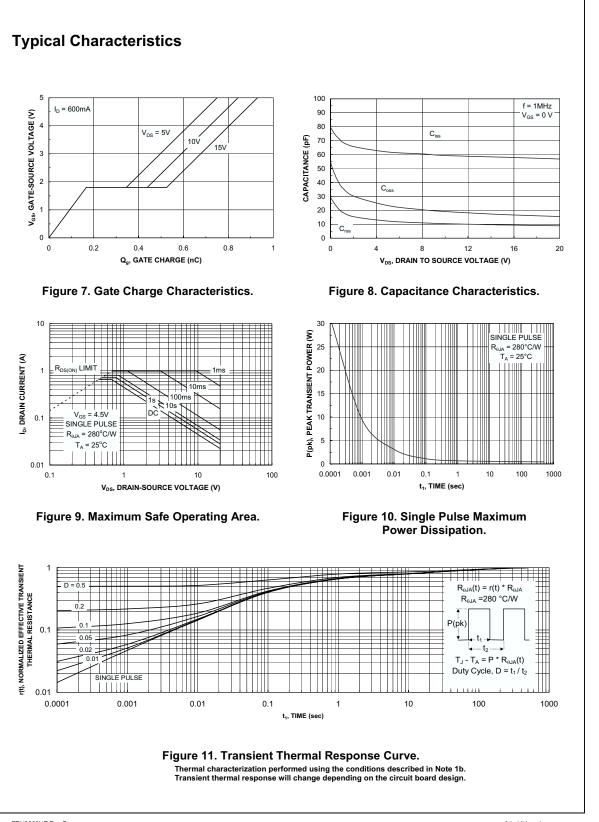
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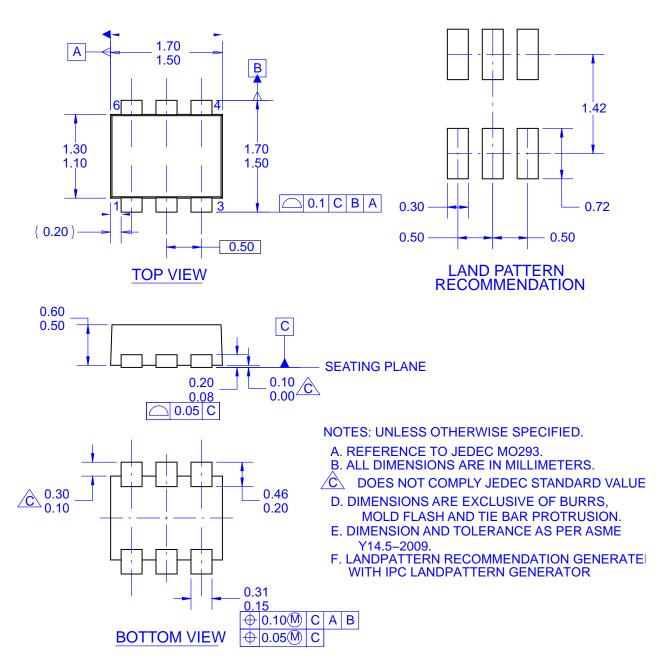
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